

Designed for surface mounting on high density circuit board Emboss carrier tape packing systems is available for automatic insertion.



Range: (µF)	100
Voltage: (V)	63
Ripple Current of this item: (mA)	280
Size of this item: (mm)	10x10,5
Operating Temperature:	40°V ~ + 85°C
Capacitance Tolerance:	.+/- 20% at 120Hz, 20°C

Ripple Current at 85°C, 120Hz (mA rms)

DRW:

APPD:

Jason

Schumi

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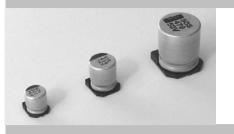
Frequency Correction Factor of Rated Ripple Current

Frequ	iency	50Hz	120Hz	300Hz	1KHz	10Khz
Capacitance	Range					
Ø= 4,0 ~	0,1 ~68	0,70	1,00	1,17	1,36	1,50
10mm	100 ~ 3300	0,85	1,00	1,08	1,20	1,30
Ø 12,5 ~	~ 68	0,75	1,00	1,35	1,57	2,00
16mm	100 ~ 680	0,80	1,00	1,23	1,34	1,50
Tomm	1000 ~ 6800		1,00	1,10	1,13	1,15

For Ø 4 ~10mm, after 2 minutes aplicat								ated vol	tage, lea	akage cu	irrents is	s not mo	re than
Leakan	e Currer	ht	0,01CV	or 3(µA), wiche	ver is gr	eater.							
сеакау	e Currer	ц		2,5 ~16mm, afte)3CV or 4(µA), v		•		of rated	voltage,	leakage	e current	s is not	more
				M	easurem	ent freq	uency:	120Hz, 1	Fempera	ature: 20	°C		
	Tan		Rated	Voltage (VDC)	4	6,3	10	16	25	35	50	63	100
	Tan		Tan ð	Ø4~10mm	0,35	0,26	0,2	0,16	0,14	0,12	0,12	0,1	0,1
			Tano	Ø12,5~16mm	0,42	0,38	0,34	0,3	0,26	0,22	0,18	0,14	0,1
				oility at Low Tem	perature	e: Mea	sureme	nt freque	ency: 12	0Hz,			
	Ra	ated Vol	tage (VD	C)	4	6,3	10	16	25	35	50	63	100
Impo	danco	Ø4~*	10mm	Z(-25°C/Z(20°C)	7	4	3	2	2	2	2	2	2
-	ratio ZT/Z20					8	6	4	4	3	3	3	3
	ax.)	7(-25			7	5	4	3	2	2	2	2	2
(un.)	012,0	Tomm	Z(-40°C/Z(20°C)	17	12	10	8	5	4	3	3	3
Load				ication of rated tord meet the	Capac	itance C	Change	Withir		of the i f the init		ue(Wit for 4V	hin +/-
Life	chara	cteristic	s require	ement listed at		Tan ð		200	% or les	s of the	initial sp	ecified c	alue
			right.		Leal	age Cu	rrent		Initial	specifie	d value o	or less	
:	Shelf Life	е	After le	aving capacitors				for 1000 istics lis		-	et the sp	ecified v	alue for
			After ref	low soldering and	restored	Capao	itance C	bango	\\/i+i	oin +/ 20	1% of the	e initial v	aluo
Re	esistance	e to	at room t	temperature, they	meet the	Capac	Tan ð	nanye			,	lue or le	
so	ldering h	eat	characte	eristics requirement	nts listed	l eal	kage Cu	rrent				lue or le	
				at above		Lea	lage ou	nont		illai spe	cilieu va		33
Ap	plicable	Standa	rds	JIS C-5141 and	JIS C-5	102							
	SMT Electrolytic Capacitor												

								SMI Electroly Serie	
								Serie No.:	I15001
CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customer:	
		FINISH	Jamy		Shee	t No.	1 from 10	Customer.	
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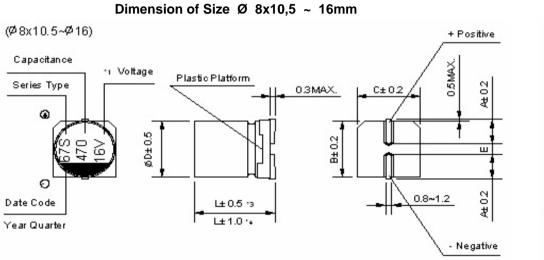
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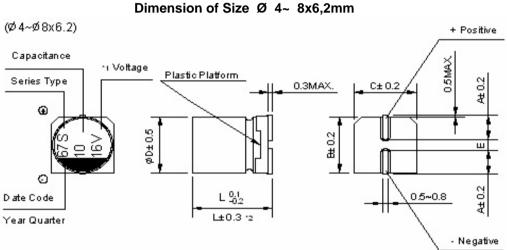


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Technical Drawing





DxL	Ø 4 x 5.4	Ø 5 x 5.4	Ø 6,3 x 5.4	Ø 6,3 x 7,7	Ø 8 x 6,2	Ø 8 x 10,5	Ø 10 x 10,5	Ø 10 x 13,5	Ø 12.5 x 13,5	Ø 12,5 x 16	Ø 16 x 16,5
Α	1,8	2,1	2,4	2,4	3,3	2,9	3,2	3,2	4,7	4,7	5,5
В	4,3	5,3	6,6	6,6	8,3	8,3	10,3	10,3	12,8	12,8	16,3
С	4,3	5,3	6,6	6,6	8,3	8,3	10,3	10,3	12,8	12,8	16,3
E +/-0.2	1,0	1,3	2,2	2,2	2,2	3,1	4,4	4,4	4,4	4,4	6,7
L	5,4	5,4	5,4	7,7	6,2	10,5	10,5	13,5	13,5	16,0	16,5

*1 Voltage mark (6V) reprents 6,3V for Ø 4 ~ 10mm

*3 (L +/- 0.5) is applicable to Ø 8x10,5 ~ Ø 10mm

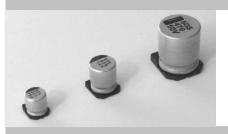
*2 (L +/- 0.3) is RE. Date code a 3rd character fo	and seriew type				. ,	applicable to Ø 1 e year area 1,4,7,0					ytic Capacitor e SS
										Serie No.:	l15001
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customer:	
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REACH

RoHS Lead Free



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Ordering Informations

Serie	Volt	Tolerance	Range	Size Code	Material	Special	ROHS	Packing	
I15001	630	М	101	G0	XX	00	R	TR	

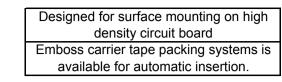
630 = 63V	M= Tolerance 20%	101 = 100µF	G0 = 10x10,5	XX = No Funktion	00 = No Funktion	R = ROHS Conform	TR= TAPE Reel
	K= Tolerance 10%					N = NON ROHS	BU= Bulk- Ware
						Conform	

										SMT Electroly	/tic Capacitor
										Serie	e SS
_										Serie No.:	l15001
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customer:	
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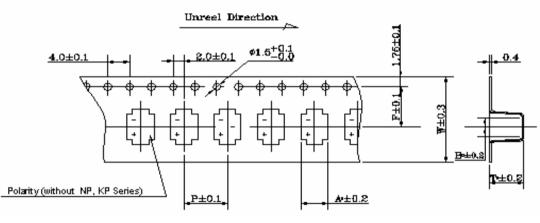




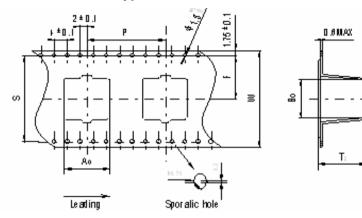
Taping Specification

Carrier Type Ø4 ~ 10mm

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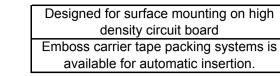
Carrier Type Ø 12,5 ~ 16mm



DxL	4x5,4/5,8	5x5,4/5,8	6,3x5,4/5,8	6,3x7,7	8x6,2	8x10,5	10x10,5/13,5	12,5x13,5/16	16x16,5
W	12,0	12,0	16,0	16,0	16,0	24,0	24,0	32,0	44,0
Р	8,0	12,0	12,0	12,0	12,0	16,0	16,0	24,0	28,0
F	5,5	5,5	7,5	7,5	7,5	11,5	11,5	14,2	20,2
A0	5,0	6,0	7,0	7,0	8,7	8,7	10,7	14,0	17,5
B0	5,0	6,0	7,0	7,0	8,7	8,7	10,7	14,0	17,5
T2	5,8/6,3	5,8/6,3	5,8/6,3	8,4	6,8	11,0	11,7/14,0	14,0/16,5	17,5
S								28,4	40,4

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										Serie No.:	I15001
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customer:	
APPD:	Schumi			FINISH	Jamy		Shee	t No.	4 from 10	Customer.	
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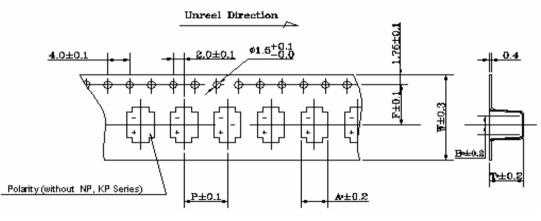




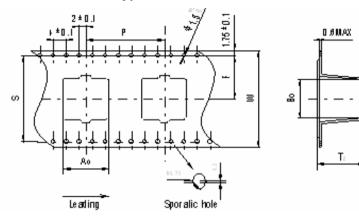
Taping Specification

Carrier Type Ø4 ~ 10mm

2 3



Carrier Type Ø 12,5 ~ 16mm



DxL	4x5,4/5,8	5x5,4/5,8	6,3x5,4/5,8	6,3x7,7	8x6,2	8x10,5	10x10,5/13,5	12,5x13,5/16	16x16,5
W	12,0	12,0	16,0	16,0	16,0	24,0	24,0	32,0	44,0
Р	8,0	12,0	12,0	12,0	12,0	16,0	16,0	24,0	28,0
F	5,5	5,5	7,5	7,5	7,5	11,5	11,5	14,2	20,2
A0	5,0	6,0	7,0	7,0	8,7	8,7	10,7	14,0	17,5
B0	5,0	6,0	7,0	7,0	8,7	8,7	10,7	14,0	17,5
T2	5,8/6,3	5,8/6,3	5,8/6,3	8,4	6,8	11,0	11,7/14,0	14,0/16,5	17,5
S								28,4	40,4

							SMT Electrolytic Capacitor Serie SS				
										Serie No.:	I15001
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customer:	
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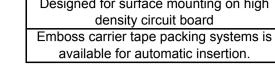
Taping Specification

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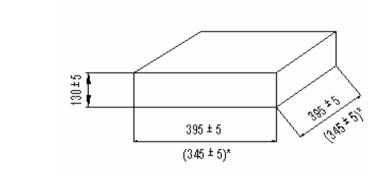
23

13±0.5





Box



Size	Reel (PCS)	In-Box (reels)	Quantity / In-Box (pcs)	4 in-Boxes / Carton (/pcs)				
4x5,4/5,8	2000	6	12000	48000				
5x5,4/5,8	1000	6	6000	24000				
6,3x5,4/5,8	1000	5	5000	20000				
6,3x7,7	1000	5	5000	20000				
8x6,2	1000	5	5000	20000				
8x10,5	500	4	2000	8000				
10,x10,5	500	4	2000	8000				
10x13,5	300/250	4	1200/1000	4800/4000				
12,5x13,5	200/150	3	600/450	2400/1800				
12,5x16	200/150	3	600/450	2400/1800				
16x16,5	125	2	250	1000				
SMT Electrolytic Conscitor								

SMT Electrolytic Capacitor

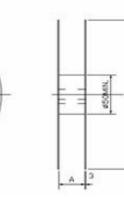
Serie SS

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	DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customor	
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Reel



DxL	4x5.4/5.8	5x5.4/5.8	6,3x5,4/5,8/7,7	8x6.2/10.5
A	14	14	18	26
В	382	392	382	382

DxL	10x10,5	10x13,5	12,5x13,5/16	16x16,5
A	26	26	34	46
В	382	382 / 332	382/332	332

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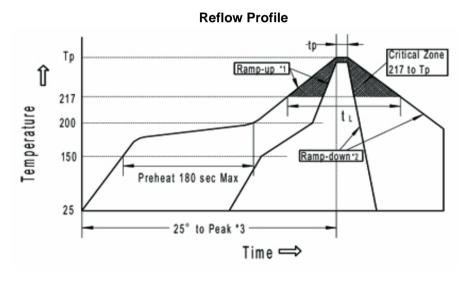


Reflow Soldering Conditions

- 1 A thermal condition system such as infrared radiation (IR) or hot blast shall be adopted, and vapor heat transfer systems (VPS) are not recommended.
- 2 Reflow shall be done within 2 cycles. Please make sure that the parts have enough cooling time.
- 3 The time of preheating from 150°C to 200°C shall be within 180 seconds maximum;

The time of soldering temperature at 217°C measured on capacitors' top shall not exceed t_L (second);

The peak temperature on capacitors' top shall not exceed Tp(°C), and the time within 5^AC of actual peak temperature shall not exceed tp (second).



U	Classified at Temperature and Time for all Products									
Size Thickness/mm		Volume/mm ³	Tp (°C)	tl / second	tp / second					
Ø 4~ 6,3 & Ø 8x6,2L	> 2.5	< 350	250 +/- 0	90	40					
Ø 8~ 10,5 L	> 2.5	350 ~2000	240 +/- 0	90	30					
Ø10~10,5 / 13,5L	> 2.5	350 ~2000	235 +/- 0	60	30					
Ø12,5 & Ø 16	> 2.5	> 2000	230 +/- 0	30 (20)	20					
	Peter to table 4-2, 5-2 and Figure 5-1, IPC / IEDEC, LSTD.020C									

Cleasified at Temperature and Time for all Breducto

Refer to table 4-2. 5-2 and Figure 5-1, IPC / JEDEC J-STD-020C

Re: (20)X is special for midh or high voltage V-Chip capacitors which is Serie H serie made by EDCON.

Classified at Temperature and Time Only for Standard Site without								
Size	Thickness/mm	Volume/mm ³	Tp (°C)	tl / second	tp / second			
Ø 4~ 6,3 & Ø 8x6,2L	> 2.5	< 350	260 +/- 0	90	5			
Ø 8~ 10,5 L	> 2.5	350 ~2000	260 +/- 0	90	5			
Ø10~10,5 / 13,5L	> 2.5	350 ~2000	260 +/- 0	60	5			

SMT Electrolytic Capacitor Serie SS Serie No.: 115001

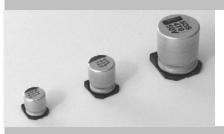
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	DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.02.2010	Customor		
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1 Average ramp-up rate is 3°C/second max. 2 Ramp-down rate is 6°C/second max.

3 Time from 25°C to peak temperature is 8 minutes max.

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Application Guideline for CHIP Aluminium Electrolytic Capacitors

1. Circuit Design

a. Please make sure the environmental and mounting conditions to which the capacitor will be exposed are within the conditions specified in EDCON catalogue.

b. Operating temperature and applied ripple shall be within EDCON specification.

c. Appropriate capacitors which comply with the life requirement of the products should be selected when designing the circuit.

d. Aluminum electrolytic capacitors are polar. Make sure that no reverse voltage or AC voltage is applied to the capacitors. Please use bi-polar capacitors for a circuit that can possibly see reversed polarity. Even bi-polar capacitors cannot be used for AC Voltage application.

e. Do not use aluminum electrolytic capacitors in a circuit that requires rapid and very frequent charge / discharge. In this type of circuit, it is necessary to use a special design capacitor with extended life characteristics.

f. Do not apply excess voltage.

Please pay attention to that the peak voltage, which is DC voltage overlapped by ripple current, will not exceed the rated voltage.

In the case where more than 2 aluminum electrolytic capacitors are used in series, please make sure that applied voltage will be lower than rated voltage and the voltage will be applied to each capacitor equally by using a balancing resistor in parallel with the capacitor.

g. Aluminum electrolytic capacitors shall not be used under the following environmental conditions: Capacitors will be exposed to water (including condensation), brine or oil.

Ambient conditions that include toxic gases such as hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, bromine, methyl bromide, ammonium, etc.

Ambient conditions that expose the capacitor to ozone, ultraviolet ray and radiation.

Severe vibration and physical shock conditions that exceed KJ specification.

	vibration freque	ncy range		10~55			
	sweep rate			10~55			
condition:	sweep method			logarith			
	amplitude or ac		1.5mm	(max. accelerati			
	direction of vibr	ation		X, Y, Z			
	testing time			2 hours	ion		
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and the second							

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Shock is not applicable normally.

If a particular condition is required, please contact our sales office.

The main chemical solution of the electrolyte and the separator paper used in the capacitors are combustible. The electrolyte is conductive. When it comes in contact with the PC board, there is a possibility of pattern corrosion or short circuit between the circuit pattern, which could result in smoking or catching fire. Do not locate any circuit pattern beneath the capacitor end seal.

Do not design a circuit board that the heat generating components are placed near the aluminum electrolytic capacitor or on the reverse side of PC board, if that just under the capacitor.

Please refer to the table of land size(mm) below when you design in surface mount capacitors.

Electrical characteristics may vary depending on changes in temperature and frequency. Please consider this variation when you design circuits.

When you install more than 2 capacitors in parallel, please consider the balance of current flowing into the capacitors.

While mounting capacitors on double-side PC board, the capacitors should be away from those unnecessary base plate holes and connection holes.

Cap Size	а	b	С
Ø4	1,0	2,6	1,6
Ø5	1,4	3,0	1,6
Ø6,3L	2,1	3,5	1,6
Ø8x6,2L	2,1	4,0	1,6
Ø8x10,5L	3,0	3,5	2,5
Ø10	4,0	4,0	2,5
Ø12,5	4,0	5,7	3,0
Ø16	6,0	6,5	3,5

DATE

Mason

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SMT Electrolytic Capacitor Serie SS							
Serie No.:	I15001						
Customer:							

email: info@edcon-components.com

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Application Guideline for CHIP Aluminium Electrolytic Capacitors

2. Mounting

Once a capacitor has been assembled in the set and power applied, do not attempt to re-use the capacitor in other circuits or application.

Leakage current of the capacitors that have been stored for more than 2 years may increase. When leakage current has increased, please perform a voltage treatment using a $1k\Omega$ resistor.

Please confirm specifications and polarity before installing capacitors on the PC board.

Do not drop capacitors on the floor, nor use a capacitor that was dropped.

Do not deform the capacitor during installation.

Please pay attention to the mechanical shock to the capacitor by suction nozzle of the automatic insertion machine or automatic mounter, or by product checker, or by centering mechanism.

Reflow soldering

Please follow "Reflow Soldering Conditions" in EDCON's catalogue.

When an infrared heater is used, please pay attention to the extent of heating since the absorption rate of infrared will vary due to difference in the color and size of the capacitor.

Do not tilt lay down or twist the capacitor body after the capacitor are soldered to the PC board.

Do not carry the PC board by grasping the soldered capacitor.

Please do not allow anything to touch the capacitor after soldering. If PC boards are stored in stack, please make sure the PC board or other components away from the capacitor.

The capacitors shall not be effected by any radiated heat from the soldered PC board or other components after soldering.

Cleaning

Recommended cleaning method							
Applicable	Any type, any ratings						
Cleaning agents	Pine Alpha ST-100S, Clean Through 750H/750L/710M, Sanelek						
	B-12, Aqua Cleaner 210SEP, Techno Care FRW14 ~ 17, Isopropyl Alcohol.						
- · · · · · · · · · · · · · · · · · · ·							

Cleaning conditions

Total cleaning time shall be within 2 minutes by immersion, ultrasonic or other methods. Temperature of the cleaning agents shall be 40 or below. After cleaning, capacitors should be dried by using hot air for the minimum 10 minutes along with the PC board mounted. Hot air temperature should be within the maximum operating temperature of the capacitor. Insufficient dryness after water rinse may cause appearance problems, such as bottom-plate bulge and etc.

Avoid using ozone destructive substances as cleaning agents for protecting global environment.

Please consult us regarding other cleaning agents or cleaning methods.

3. In the Equipment

Do not directly touch terminal by hand.

Do not link positive terminal and negative terminal by conductor, nor spill conductible liquid such as alkaline or acidic solution on or near the capacitor.

Please make sure that the ambient conditions where the set is installed are free from spilling water or oil, direct sunlight, ultraviolet rays, radiation, poisonous gases, vibration or mechanical shock.

Do not clean capacitors with halogenated cleaning agent. However, if it is necessary to clean with halogenated cleaning agent, please contact our sales office.										SMT Electrolytic Capacito Serie SS	
										Serie No.:	I15001
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Application Guideline for CHIP Aluminium Electrolytic Capacitors

4. Maintenance and Inspection

Please periodically inspect the aluminum capacitors that are installed in industrial equipment. The following items should be checked:

Appearance: remarkable abnormality such as pressure relief vent opening, electrolyte leaking, etc.

Electrical characteristics: capacitance, dielectric loss tangent, leakage current and etc., which are specified in KJ's catalogue or alternate product specification.

5. In an Emergency

If you see smoke due to operation of safety vent, please turn off the main switch or pull out the plug from the outlet.

If you breathe the gas or ingest the electrolyte, please wash out your mouth and throat with water immediately.

If your skin is exposed to the electrolyte, please wash it away using soap and water.

6. Storage

Do not keep capacitor in high temperature and high humidity atmosphere.

Storage conditions should be:

Temperature: 5°C ~ 35°CHumidity: lower than 75%Place: Indoor

Avoid ambient conditions where capacitors are covered with water, brine or oil.

Avoid ambient conditions where capacitors are permeated by poisonous gases such as hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, bromine, methyl bromide, ammonium and etc.

Avoid ambient conditions where capacitors are exposed to ozone, ultraviolet ray or radiation.

7. Disposal

Please take either of the following methods in disposing capacitors. Incinerate them after crushing capacitors or making a hole on the capacitor body. If incineration is not applicable, hand them over to a waste disposal agent and have them buried in landfills.

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